

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
Name	Execution Date
Marius K. Orlowski	01/10/2006
James D. Burnett	01/10/2006
<b>RECEIVING PARTY DATA</b>	
Name:	Freescall Semiconductor, Inc.
Street Address:	6501 William Cannon Drive West
Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
Postal Code:	78735
<b>PROPERTY NUMBERS Total: 1</b>	
Property Type	Number
Application Number:	12753226
<b>CORRESPONDENCE DATA</b>	
Fax Number:	(512)439-7199
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	512-439-7100
Email:	mharrison@LNAlaw.com
Correspondent Name:	J. Gustav Larson
Address Line 1:	5914 West Courtyard Drive
Address Line 2:	Suite 200
Address Line 4:	Austin, TEXAS 78730
ATTORNEY DOCKET NUMBER:	SC14305TP-D1
NAME OF SUBMITTER:	J. Gustav Larson
<p>Total Attachments: 3</p> <p>source=SC14305TP_Assignment#page1.tif</p>	

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**PATENT**  
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## PATENT APPLICATION

## ASSIGNMENT OF U.S. PATENT APPLICATION

This is an assignment of patent rights between the inventor(s)

**Marius K. Orlowski**

**James D. Burnett**

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **Marius K. Orlowski and James D. Burnett** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **FREESCALE SEMICONDUCTOR, INC.**, a corporation of the State of Delaware, having its principal office in Austin, Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **ELECTRONIC DEVICE INCLUDING A FIN-TYPE TRANSISTOR STRUCTURE AND A PROCESS FOR FORMING THE ELECTRONIC DEVICE** (Docket No. SC14305TP), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto **FREESCALE SEMICONDUCTOR, INC.**, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefore in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize **FREESCALE SEMICONDUCTOR, INC.** to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to **FREESCALE SEMICONDUCTOR, INC.**, for the sole use and benefit of **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to **FREESCALE SEMICONDUCTOR, INC.**

We agree that, when requested, we will, without charge to **FREESCALE SEMICONDUCTOR, INC.**, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives or nominees.

We covenant with **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

This assignment is executed on the date(s) of which the Inventor has signed.

Inventor:

Marius K. Orlowski  
Marius K. Orlowski

1-10-06  
Date:

State of  
County of

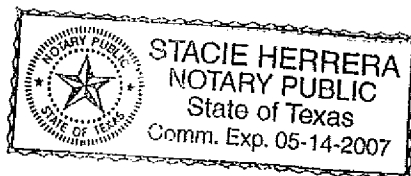
Texas  
Williamson

SS:

Before me personally appeared said inventor and acknowledge the foregoing instrument to be his/her free act and deed this 10<sup>th</sup> day of January, 2006

Seal

Stacie Herrera  
(Notary)



James D. Burnett      1/10/2006  
James D. Burnett      Date:

State of Texas      SS:  
County of Williamson

Before me personally appeared said inventor and acknowledge the foregoing instrument to be his/her  
free act and deed this 10th day of JANUARY, 2006

Seal

Dora Hudgins  
(Notary)

